

# NOT RECOMMENDED FOR NEW DESIGN CONTACT US



## DMJ70H1D3SK3

#### N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	Rds(on) max	ID MAX T <sub>C</sub> = +25°C
700V	1.4Ω @ V <sub>GS</sub> = 10V	4.7A

### **Description**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

#### **Applications**

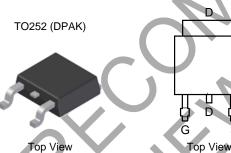
- Adaptors
- LCDs & PDP TVs
- Lighting

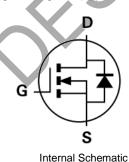
#### **Features**

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low Gate Input Resistance
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

#### **Mechanical Data**

- Package: TO252
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.33 grams (Approximate)





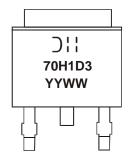
# Ordering Information (Note 4)

Part Number	Packago	Pac	Packing		
Part Number	Package	Qty.	Carrier		
DMJ70H1D3SK3-13	TO252 (DPAK)	2,500	Tape & Reel		

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



☐ I = Manufacturer's Marking

70H1D3 = Product Type Marking Code

YYWW = Date Code Marking

YY or <u>YY</u> = Last Two Digits of Year (ex: 22 = 2022)

WW or <u>WW</u> = Week Code (01 to 53)



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		VDSS	700	V
Gate-Source Voltage		Vgss	±30	V
Continuous Drain Current (Notes 5 & 9) V <sub>GS</sub> = 10V	I <sub>D</sub>	4.7 3.0	Α	
Maximum Body Diode Forward Current (Note 6)	Is	2	A	
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%)		Ism	5	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	5	А
Avalanche Current, L = 60mH		I <sub>AS</sub>	1	A
Avalanche Energy, L = 60mH		Eas	29	mJ
Peak Diode Recovery dv/dt (Note 7)		dv/dt	4	V/ns

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_C = +25^{\circ}C$ $T_C = +100^{\circ}C$	P <sub>D</sub>	57 23	W
Thermal Resistance, Junction to Ambient (Note 6)		Reja	80	°C/W
Thermal Resistance, Junction to Case (Note 5)		Rejc	2.2	C/VV
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

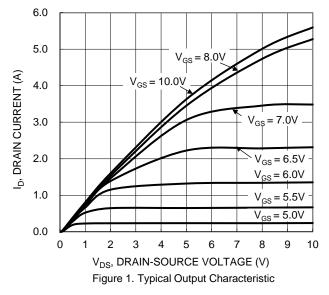
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BVDSS	700	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current	IDSS		1	1	μΑ	V <sub>DS</sub> = 700V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	-		100	nA	$V_{GS} = \pm 30V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	Vgs(th)	2		5	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
Static Drain-Source On-Resistance	Rds(on)	-	1.26	1.4	Ω	Vgs = 10V, ID = 1A
Diode Forward Voltage	V <sub>SD</sub>	_	_	1.3	V	$V_{GS} = 0V$ , $I_S = 5A$
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	Ciss	_	264			V <sub>DS</sub> = 100V, f = 1MHz, V <sub>GS</sub> = 0V
Output Capacitance	Coss	_	18	_	pF	
Reverse Transfer Capacitance	Crss	_	2.8	_		
Gate Resistance	Rg	_	4.7	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge	Qg	_	9.8	_		V <sub>DD</sub> = 480V, I <sub>D</sub> = 1.5A, V <sub>GS</sub> = 10V
Gate-Source Charge	Qgs	_	1.7	_	nC	
Gate-Drain Charge	Q <sub>gd</sub>	_	6	_		
Turn-On Delay Time	td(on)	_	9	_		$V_{DD} = 400V$ , $V_{GS} = 13V$ , $R_g = 10.2\Omega$ , $I_D = 1.5A$
Turn-On Rise Time	t <sub>R</sub>	_	11	_		
Turn-Off Delay Time	tD(OFF)	_	31	_	ns	
Turn-Off Fall Time	t <sub>F</sub>	_	19	_		
Body Diode Reverse Recovery Time	trr	_	145	_	ns	1- 4.50 di/dt 4000//
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	0.8	_	μC	Is =1.5A, di/dt = 100A/μs

Notes:

- 5. Device mounted on an infinite heatsink.
- Device mounted on FR-4 substrate PC board, 2oz. copper, with minimum recommended pad layout.
   Guaranteed by design. Not subject to production testing.
   Short duration pulse test used to minimize self-heating effect.
   Drain current limited by maximum junction temperature.







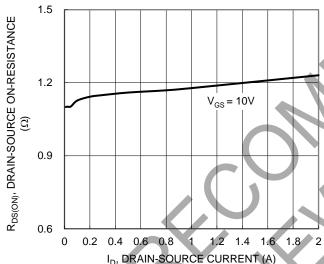


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

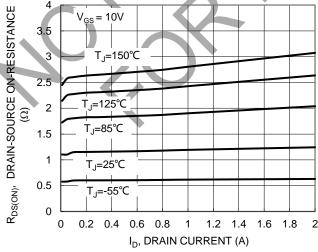
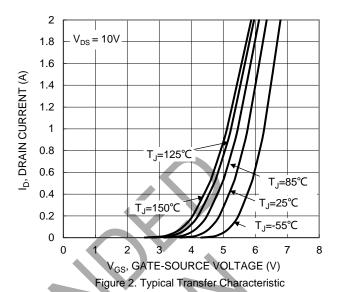
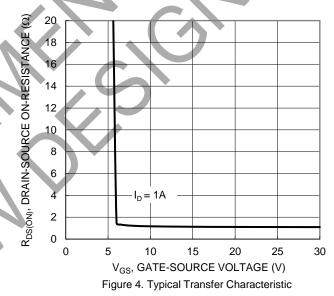


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





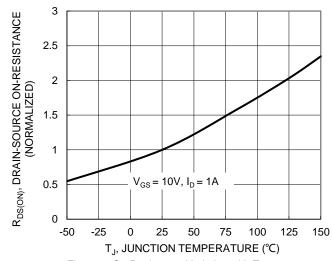
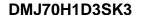


Figure 6. On-Resistance Variation with Temperature





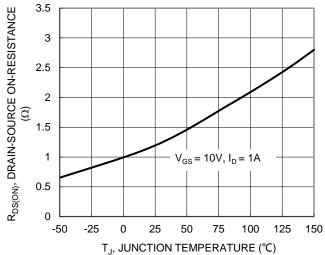


Figure 7. On-Resistance Variation with Temperature

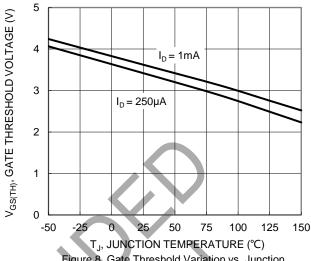


Figure 8. Gate Threshold Variation vs. Junction Temperature

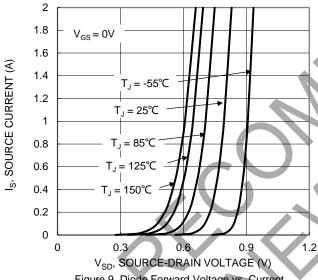
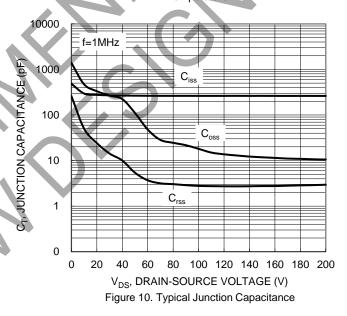
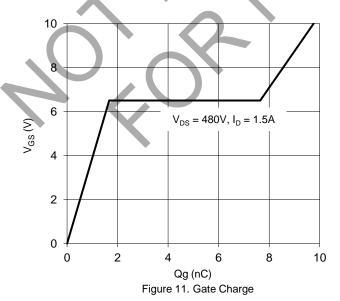
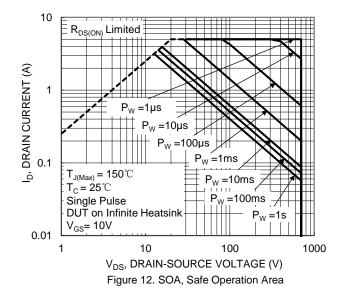


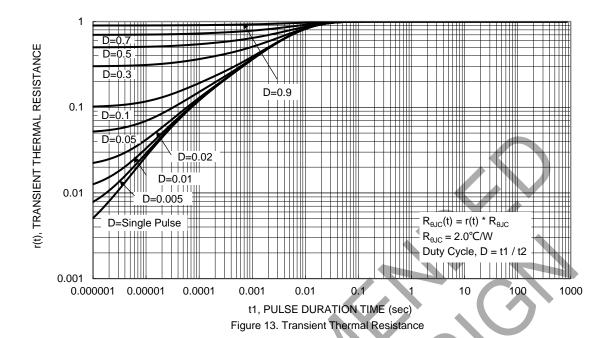
Figure 9. Diode Forward Voltage vs. Current









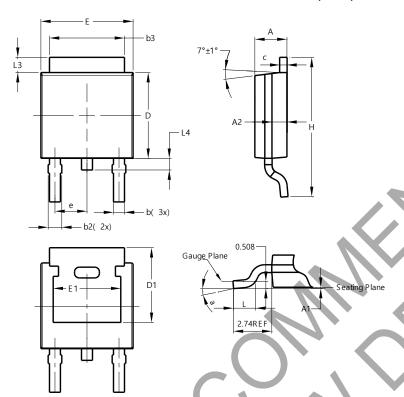




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TO252 (DPAK)

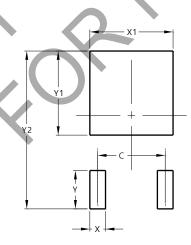


TO252 (DPAK)				
Dim	Min	Max	Тур	
Α	2.19	2.39	2.29	
A1	0.00	0.13	0.08	
A2	0.97	1.17	1.07	
b	0.64	0.88	0.783	
b2 `	0.76	1.14	0.95	
b3	5.21	5.50	5.33	
S	0.45	0.58	0.531	
Q	6.00	6.20	6.10	
D1	5.21			
е	2.286 BSC			
Ħ	6.45	6.70	6.58	
E1	4.32	)		
1	9.40	10.41	9.91	
7	1.40	1.78	1.59	
L3	0.88	1.27	1.08	
L4	0.64	1.02	0.83	
a	0°	10°		
All Dimensions in mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TO252 (DPAK)



Dimensions	Value (in mm)		
C	4.572		
X	1.060		
X1	5.632		
Y	2.600		
Y1	5.700		
Y2	10 700		



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